

SEMICONDUCTOR

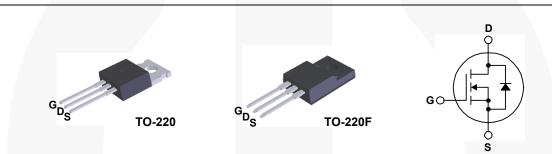
FQP13N50C / FQPF13N50C N-Channel QFET[®] MOSFET 500 V, 13 A, 480 mΩ

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize onstate resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp bridge topology.

Features

- 13 A, 500 V, $R_{DS(on)}$ = 480 m Ω (Max.) @ V_{GS} = 10 V, I_{D} = 6.5 A
- Low Gate Charge (Typ. 43 nC)
- Low Crss (Typ. 20 pF)
- 100% Avalanche Tested



Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

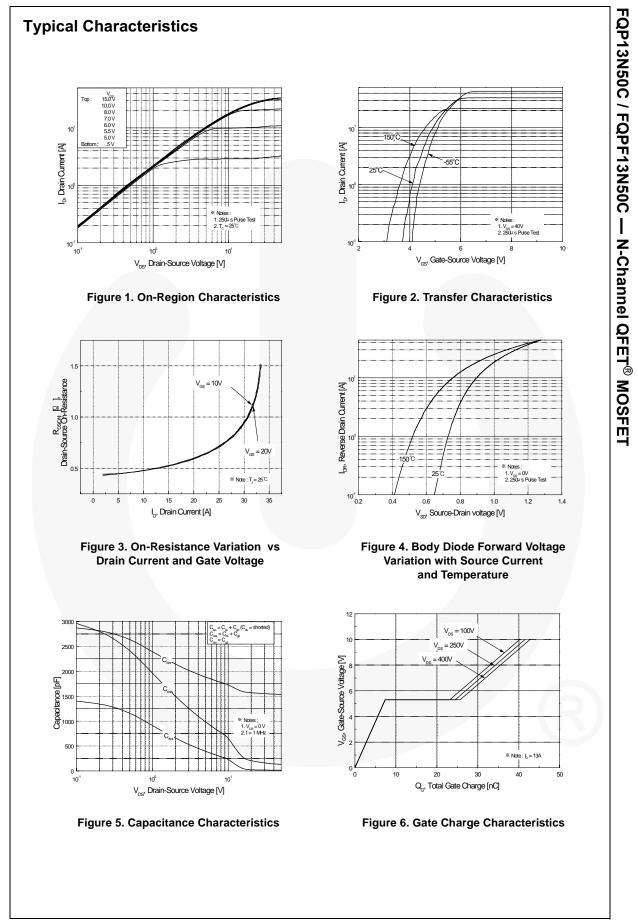
Symbol	Parameter	FQP13N50C	FQPF13N50C	Units	
V _{DSS}	Drain-Source Voltage	5	V		
I _D	Drain Current - Continuous (T _C = 25°	°C)	13	13 *	А
	- Continuous (T _C = 100)°C)	8	8 *	А
I _{DM}	Drain Current - Pulsed	(Note 1)	52	52 *	А
V _{GSS}	Gate-Source Voltage	± 30		V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	860		mJ
I _{AR}	Avalanche Current	(Note 1)	13		А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	19.5		mJ
dv/dt	Peak Diode Recovery dv/dt	4.5		V/ns	
PD	Power Dissipation ($T_C = 25^{\circ}C$)	195	48	W	
	- Derate above 25°C	1.56	0.39	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Ran	-55 to +150		°C	
TL	Maximum lead temperature for soldering	300		°C	
۲L	1/8" from case for 5 seconds				

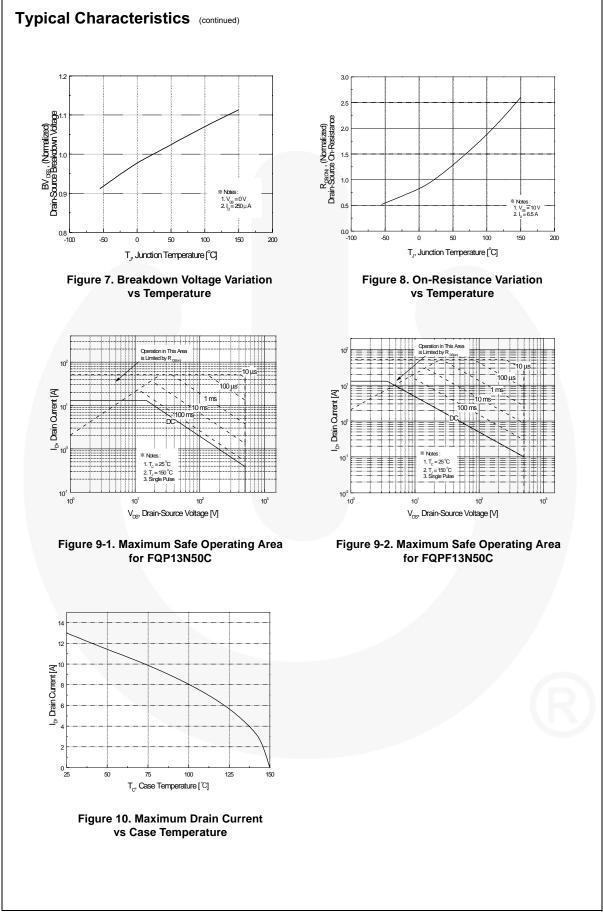
* Drain current limited by maximum junction temperature

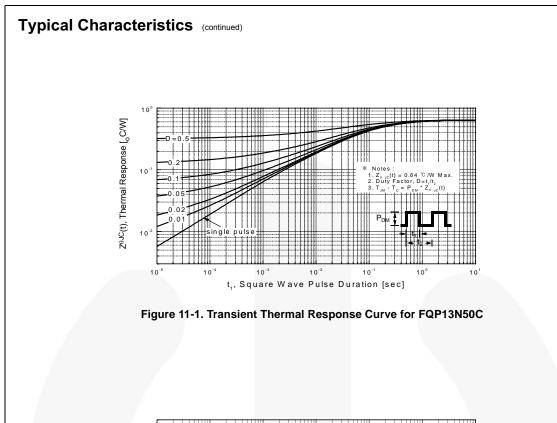
Thermal Characteristics

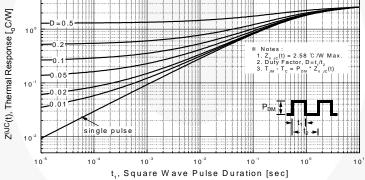
Symbol	Parameter	FQP13N50C	FQPF13N50C	Units	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.64	2.58	°C/W	
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5		°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W	

		Top Mark	Package		Packing Method Reel S		Size	Tape Width		Quantity	
		FQP13N50C	TO-2		Tube	N/.	A	N/A		50 units	
		220F Tube N/			A	N/A		50 units			
Electri	cal Cha	racteristics ⊤	_c = 25°C unl	ess otherv	vise noted.						
Symbol		Parameter			Test Conditions		Min	Тур	Max	Unit	
Off Cha	aracteristi	cs									
BV _{DSS}	Drain-Sour	rce Breakdown Volta	age V _{GS} =		0 V, I _D = 250 μA		500			V	
ΔBV _{DSS} / ΔT _J	Breakdowr Coefficient	n Voltage Temperatu	ire	I _D = 25	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$			0.5		V/°C	
I _{DSS}	SS Zero Gate Voltage Drain Current		nt	V_{DS} = 500 V, V_{GS} = 0 V					1	μA	
	Zero Gale	Voltage Drain Curre		V _{DS} = 400 V, T _C = 125°C					10	μA	
I _{GSSF}	-	Leakage Current, F				80 V, V _{DS} = 0 V			100	nA	
I _{GSSR}	Gate-Body	Leakage Current, F	Reverse	V _{GS} =	-30 V, V _{DS} = 0 V				-100	nA	
On Cha	racteristi	cs									
V _{GS(th)}	-	shold Voltage		V _{DS} =	V _{GS} , I _D = 250 μA		2.0		4.0	V	
R _{DS(on)}	Static Drain On-Resista			V _{GS} = 10 V, I _D = 6.5 A			0.39	0.48	Ω		
9 _{FS}	Forward Tr	ransconductance		V _{DS} =	40 V, I _D = 6.5 A			15		S	
	ic Charac										
C _{iss}	Input Capa		V _{DS} =		25 V, V _{GS} = 0 V,			1580	2055	-	
C _{oss}	Output Ca		_	f = 1.0 MHz				180	235	pF	
C _{rss}	Reverse Ti	ransfer Capacitance	•					20	25	pF	
Switchi	ing Chara	cteristics									
t _{d(on)}	Turn-On D			V _{DD} = 250 V, I _D = 13 A,			25	60	ns		
t _r	Turn-On R	ise Time		$R_{\rm G} = 250 {\rm V}, {\rm I_D} = 13 {\rm A},$			100	210	ns		
t _{d(off)}	Turn-Off D	elay Time						130	270	ns	
t _f	Turn-Off Fa	all Time				(Note 4)		100	210	ns	
Qg	Total Gate	Charge		V _{DS} = 400 V, I _D = 13 A, V _{GS} = 10 V				43	56	nC	
Q _{gs}	Gate-Sour	ce Charge						7.5		nC	
Q _{gd}	Gate-Drain	n Charge		(Note 4				18.5		nC	
Drain-S	T	ode Characteris Continuous Drain-Se			•				13	Α	
I _{SM}		Pulsed Drain-Source							52	A	
V _{SD}		ce Diode Forward V			= 0 V, I _S = 13 A			/	1.4	V	
•so t _{rr}		ecovery Time	onuge		$0 \text{ V}, \text{ I}_{\text{S}} = 13 \text{ A},$			410		ns	
Q _{rr}					$t = 100 \text{ A}/\mu \text{s}$			4.5		μC	
~11	ACTOR A	rse Recovery Charge			αι _Γ / αι = 100 Α/μδ			7.0		μΟ	

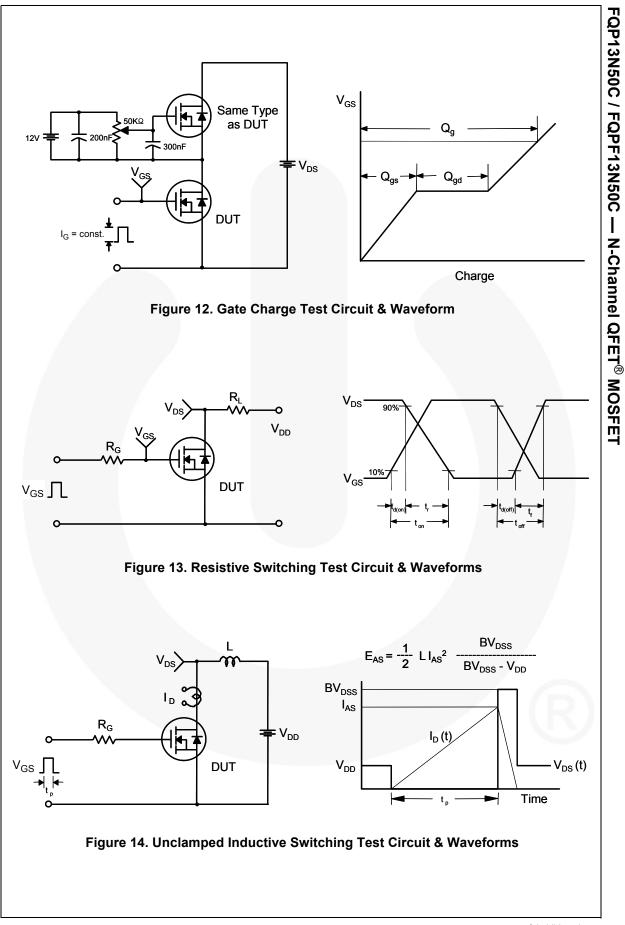


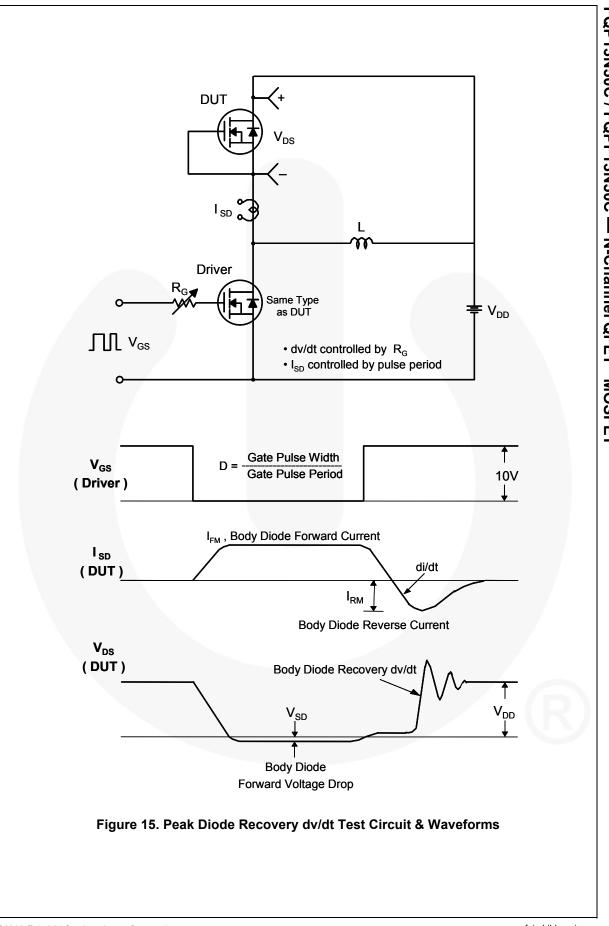


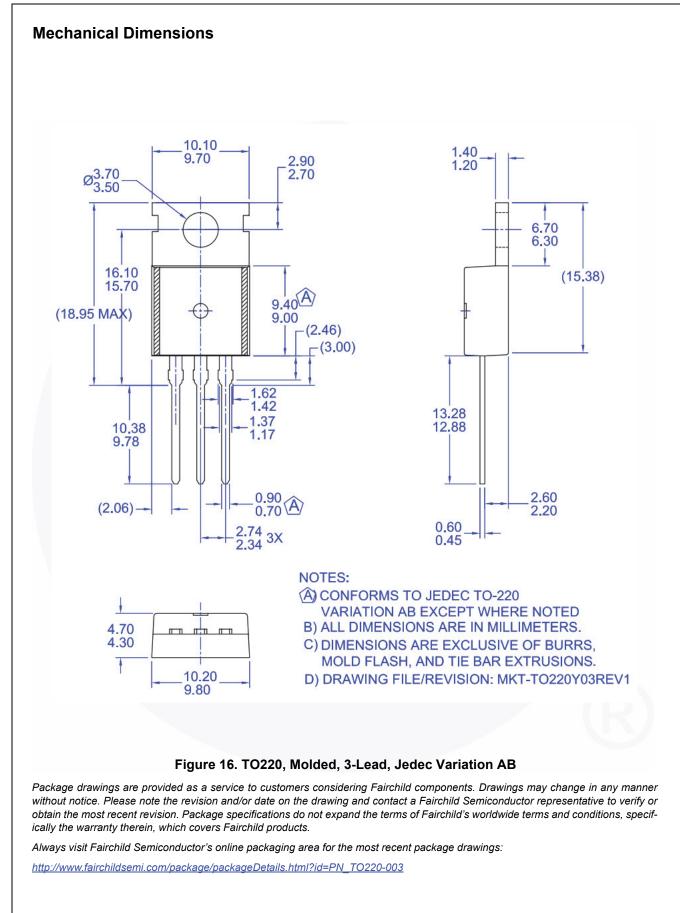


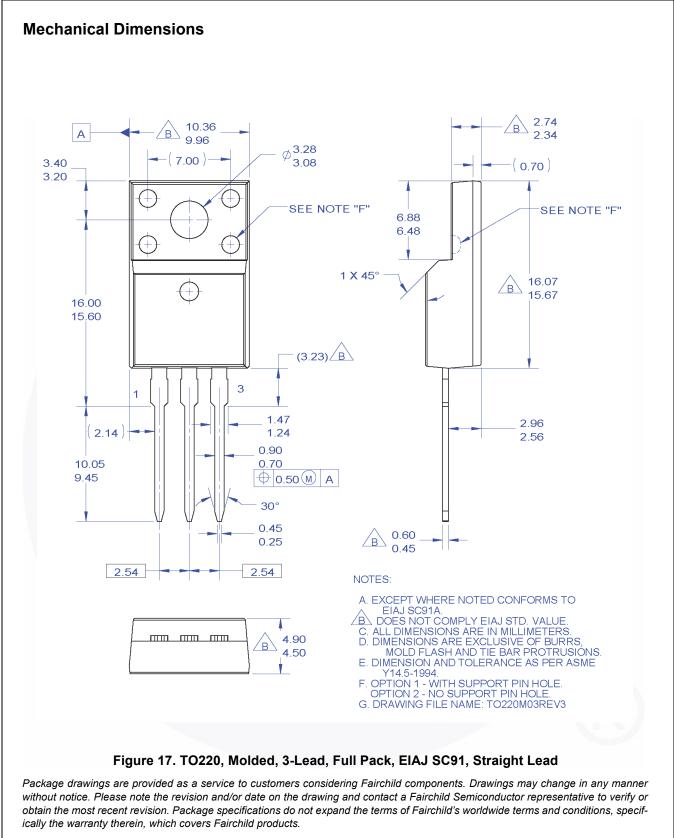












Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TF220-003

FQP13N50C / FQPF13N50C

Ì

N-Channel QFET[®] MOSFET



Datasheet Identification Product Status		Definition
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
· · · · · ·		Rev. 16

©2003 Fairchild Semiconductor Corporation FQP13N50C / FQPF13N50C Rev. C0

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UF0-7B